

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2921033

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	WON SUN SOHN	06/24/2014
	MYEONG KU YEO	06/24/2014
	KYUNG TAE KIM	06/24/2014
RECEIVING PARTY DATA		
Name:	Doosan Infracore Co., Ltd.	
Street Address:	7-11, Hwasu-dong, Dong-gu	
City:	Incheon	
State/Country:	REPUBLIC OF KOREA	
Postal Code:	401-020	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	14369043	
CORRESPONDENCE DATA		
Fax Number:	(612)334-3312	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Email:	tsorbel@wck.com	
Correspondent Name:	JOHN D. VELDHUIS-KROEZE	
Address Line 1:	900 SECOND AVENUE SOUTH, SUITE 1400	
Address Line 4:	MINNEAPOLIS, MINNESOTA 55402	
ATTORNEY DOCKET NUMBER:	D297.12-0112/JVK	
NAME OF SUBMITTER:	THERESA R. SORBEL	
SIGNATURE:	/Theresa R. Sorbel/	
DATE SIGNED:	07/01/2014	
Total Attachments: 2		
source=2014-07-01assignment#page1.tif		
source=2014-07-01assignment#page2.tif		

ASSIGNMENT

FOR PRIORITY APPLICATION ENTERING UNITED STATES

WHEREAS, We/I, SOHN, Won Sun, YEO, Myeong Ku and KIM, Kyung Tae (hereinafter referred to as ASSIGNORS), are the inventors of an invention described in:

- Korean Patent Application No. 10-2011-0144105, filed on December 28, 2011;
- International application for Letters Patent filed pursuant to the Patent Cooperation Treaty and designating the United States, and being identified by Application No. PCT/KR2012/010975, filed on December 18, 2012;
- any United States Patent Application claiming priority from the above-identified Korean and/or International patent application, the United States patent application being identifiable in the United States Patent and Trademark Office by Application No. 14/369,043, filed June 26, 2014;

WHEREAS, DOOSAN INFRACORE CO., LTD. (hereinafter referred to as ASSIGNEE), a Korean Limited liability company organized and existing under the laws of the Republic of Korea, and having a place of business at 7-11 Hwasu-don, Dong-gu, Incheon 401-020 Republic of Korea, is desirous of acquiring the entire right, title and interest in and to the invention, the application and any and all Letters Patent(s) or similar legal protection, foreign or domestic, to be obtained therefor;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, we transfer to Assignee, its successors and assigns, our entire right, title and interest in and to the invention, the above-identified application, all inventions and improvements which are disclosed in the patent applications, all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent(s) which have been or shall be filed in the United States on any of said inventions and/or improvements, all rights of priority resulting from the filing of the above-identified patent application(s), and all Letters Patent or similar legal protection issuing thereon; and we authorize the Director of the United States Patent and Trademark Office to issue the Letters Patent or similar legal protection to the Assignee.

We authorize the Assignee, its successors and assigns, to insert in this instrument the filing date and serial number of the application when ascertained.

We authorize the Assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent or similar legal protection, in its own name if desired, in any and all countries.

We represent to the Assignee, its successors and assigns, that we have not and shall not execute any writing or do any act whatsoever conflicting with this Assignment. We, our executors or administrators, will at any time upon request, without additional consideration, but at the expense of the Assignee, its successors and assigns, execute such additional writings and do such additional acts as the Assignee, its successors and assigns, may deem desirable to perfect its enjoyment of this grant, and render all assistance in making application for and obtaining, maintaining, and enforcing the Letters Patent or similar legal protection on the invention in any and all countries.

SOHN, Won Sun
Signature of Inventor

Date : JUN 24 2014

SOHN, Won Sun
Printed Name of Inventor

Residence of Inventor:
103-304, World Meridian, 297, Yeomchang-dong,

Gangseo-gu, Seoul 157-040 Republic of Korea

KIM, Ji Won
Signature of Witness

Date : Jun 24 2014

KIM, Ji Won
Printed Name of Inventor

Residence of Inventor:
15th Fl. Gusegun Bldg. 7 Chungjeong-ro

Seodaemun-gu, Seoul 120-013, Republic of Korea

Yeo M Ku
Signature of Inventor

Date : Jun. 24. 2014

YEO, Myeong Ku
Printed Name of Inventor

Residence of Inventor:
Doosan Infracore Co., 7-11, Hwasu-dong, Dong-gu
Incheon 401-020 Republic of Korea

KIM Ji Won
Signature of Witness

Date : Jun. 24. 2014

KIM, Ji Won
Printed Name of Inventor

Residence of Inventor:
15th Fl. Gusegun Bldg. 7 Chungjeong-ro
Seodaemun-gu, Seoul 120-013, Republic of Korea

Kyung Tae KIM
Signature of Inventor

Date : Jun. 24. 2014

KIM, Kyung Tae
Printed Name of Inventor

Residence of Inventor:
Doosan Infracore Co., 7-11, Hwasu-dong, Dong-gu
Incheon 401-020 Republic of Korea

KIM Ji Won
Signature of Witness

Date : Jun. 24. 2014

KIM, Ji Won
Printed Name of Inventor

Residence of Inventor:
15th Fl. Gusegun Bldg. 7 Chungjeong-ro
Seodaemun-gu, Seoul 120-013, Republic of Korea